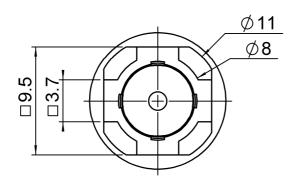
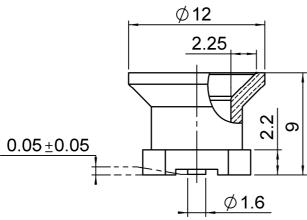
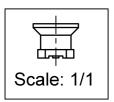
STRAIGHT MALE RECEPTACLE FOR SMT SLIDE TYPE

R328.424.510

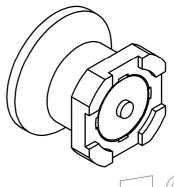
Series: BMR-SPRING







All dimensions are in mm.



COMPONENTS	MATERIALS	PLATING (μm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	BRASS BRASS PEEK	NPGR NPGR
-	- -	- -

Issue: 1042 A

In the effort to improve our products, we reserve the right to make changes judged to be



STRAIGHT MALE RECEPTACLE FOR SMT

SLIDE TYPE

R328.424.510

Series: BMR-SPRING

PACKAGING

Standard	Unit	Other
100	'W' option	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance **50** Ω Frequency **0-8** GHz

VSWR 1.2* + **0,0000** x F(GHz) Maxi

0.1** $\sqrt{F(GHz)}$ dB Maxi Insertion loss RF leakage **TBT** - F(GHz)) dB Maxi

Voltage rating 500 Veff Maxi Dielectric withstanding voltage 1000 Veff mini Insulation resistance **5000** M Ω mini

ENVIRONMENTAL

-40/+120 ° C Operating temperature

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHER CHARACTERISTICS

Assembly instruction NA

Others:

*up to 3GHz, 0-6GHz:1.25Max,0-8GHz:1.35 *Measured by one bullet+two connectors *,**Coaxial Transmission Line Only

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end 18 N mini Axial force – Opposite end **18** N mini Torque NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

2,9610 g Weight

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necessary.



STRAIGHT MALE RECEPTACLE FOR SMT

SLIDE TYPE

R328.424.510

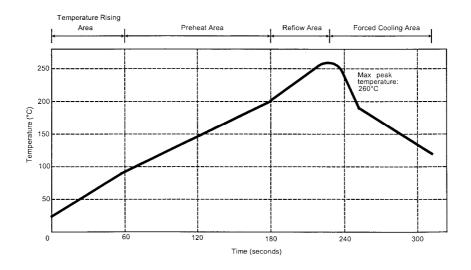
Series: BMR-SPRING

SOLDER PROCEDURE

- 1. Deposit solder paste 'SnAg4Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component . Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged .

Verification of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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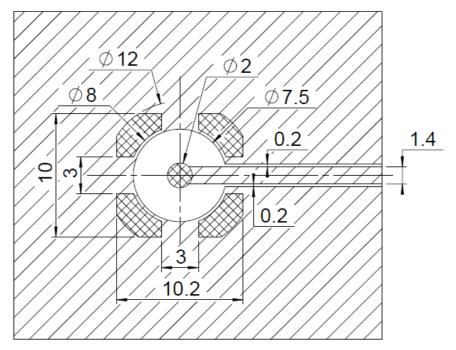


STRAIGHT MALE RECEPTACLE FOR SMT SLIDE TYPE

R328.424.510

Series: BMR-SPRING

PCB Layout

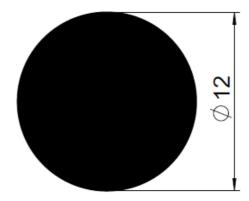


Land for solder paste

////// Pattern

COPLANAR LINE: Pattern and signal are on the same side. Thickness of PCB = 1.5 mm(double sides). The material of PCB is RO4350. The solder resist should be printed except for the land pattern on the PCB.

Shadow of receptacle for video camera



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